



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

CPH5517 — PNP/NPN Epitaxial Planar Silicon Transistors

High-Current Switching Applications

Applications

- relay drivers, lamp drivers, motor drivers

Features

- Composite type with a PNP/NPN transistor contained in package, facilitating high-density mounting
- The CPH5517 consists of two chips which are equivalent to the CPH3116 and the CPH3216, respectively
- Ultrasmall package permitting applied sets to be small and slim (mounting height : 0.9mm)

Specifications () : PNP

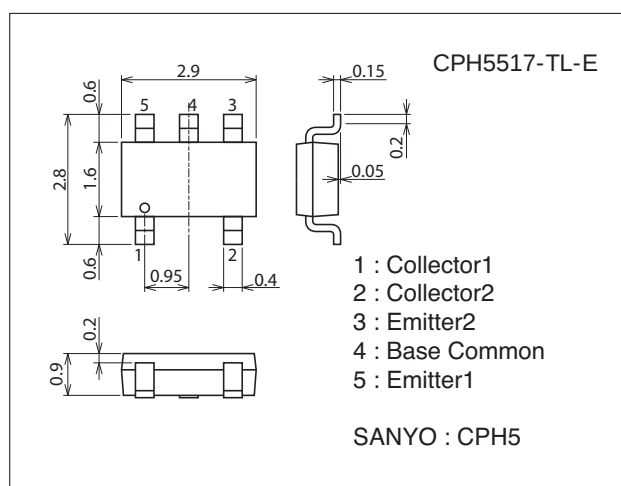
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V _{CBO}		(-50)60	V
Collector-to-Emitter Voltage	V _{CEO}		(-)50	V
Emitter-to-Base Voltage	V _{EBO}		(-)5	V
Collector Current	I _C		(-)1.0	A
Collector Current (Pulse)	I _{CP}		(-)3	A
Base Current	I _B		(-)200	mA
Collector Dissipation	P _C	Mounted on a ceramic board (600mm ² ×0.8mm) 1unit	0.9	W
Junction Temperature	T _j		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

Package Dimensions

unit : mm (typ)

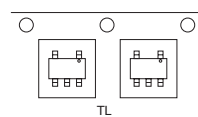
7017A-008



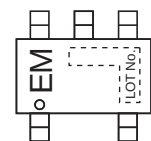
Product & Package Information

- Package : CPH5
- JEITA, JEDEC : SC-74A, SOT-25
- Minimum Packing Quantity : 3,000 pcs./reel

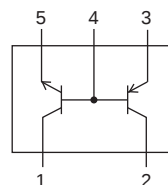
Packing Type : TL



Marking



Electrical Connection

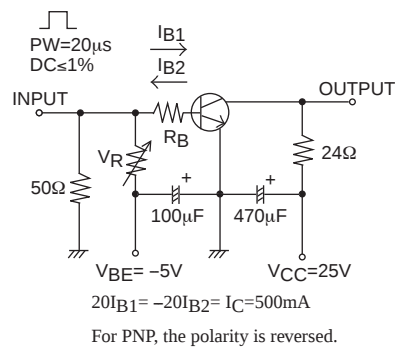


CPH5517

Electrical Characteristics at Ta=25°C

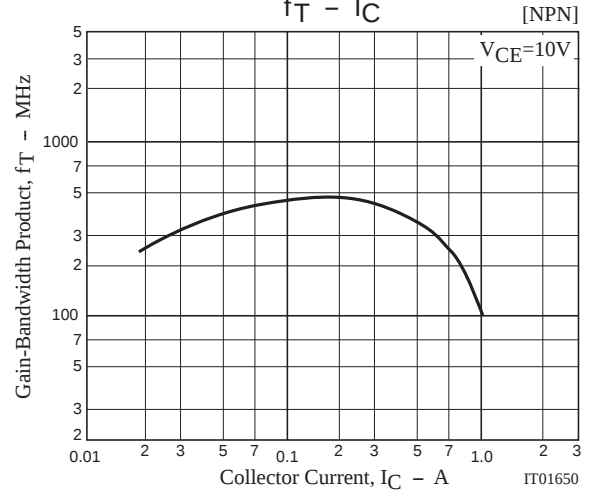
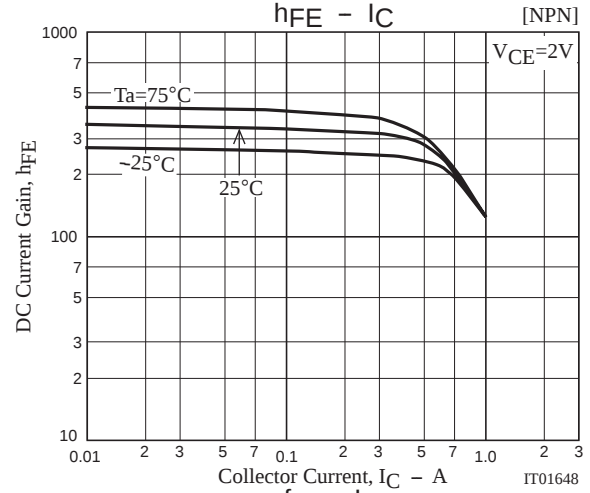
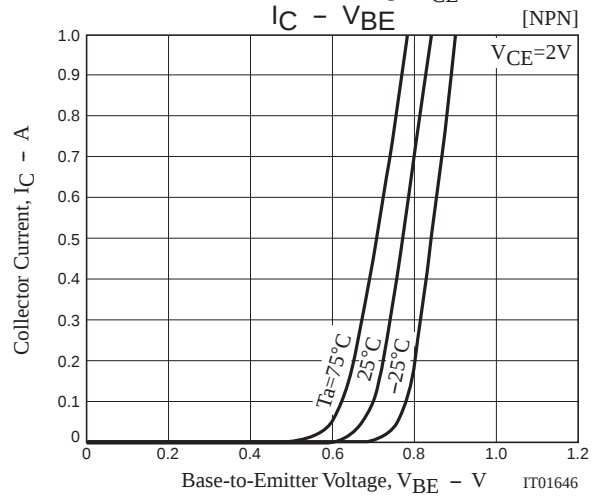
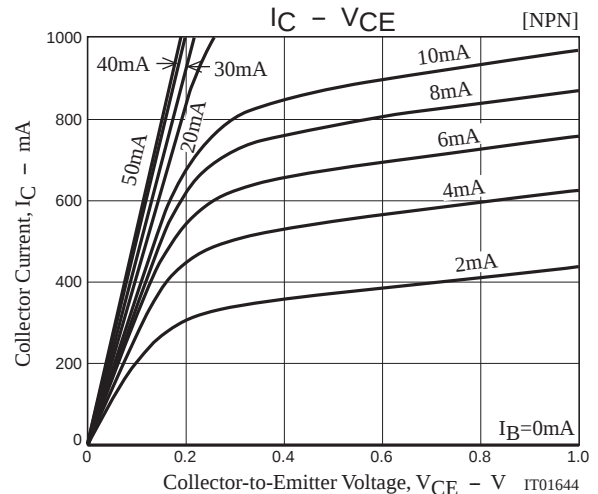
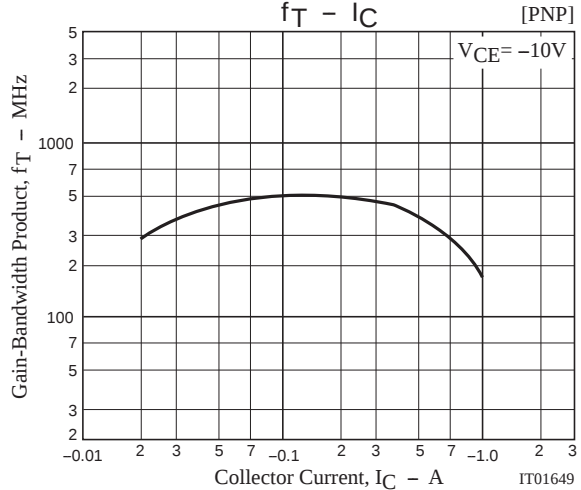
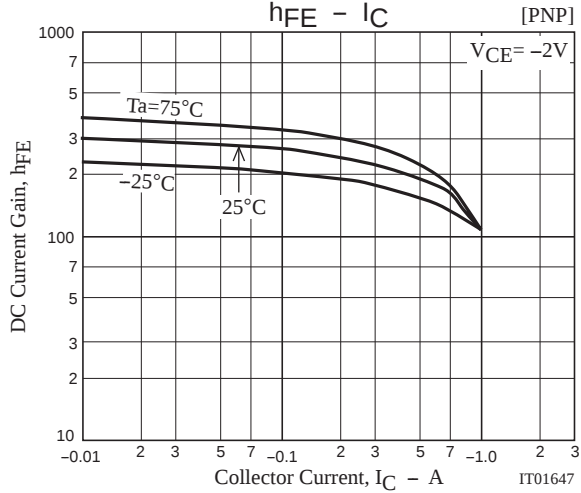
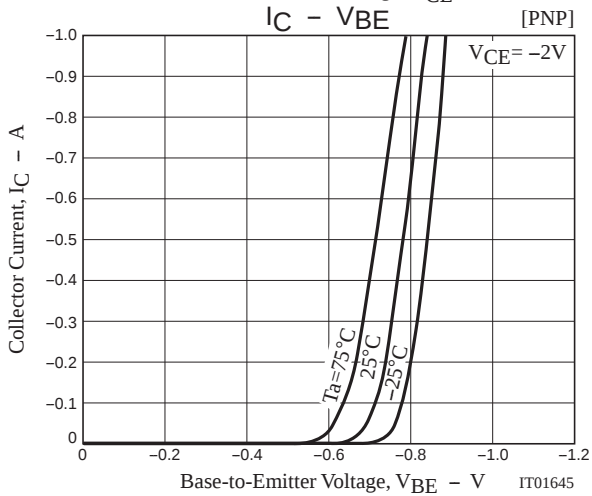
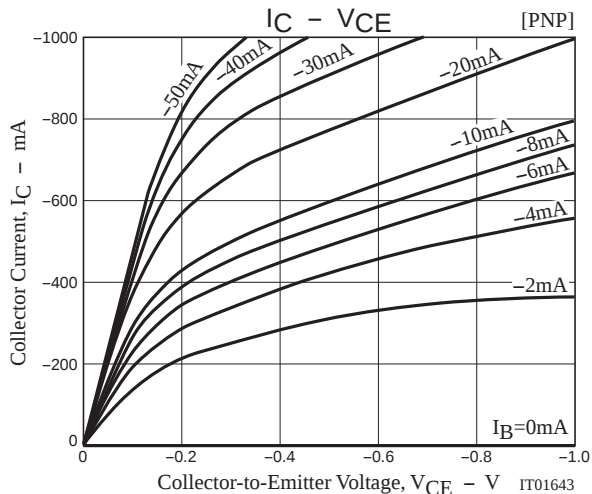
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	ICBO	V _{CB} =(-)40V, I _E =0A			(-)0.1	μA
Emitter Cutoff Current	IEBO	V _{EB} =(-)4V, I _C =0A			(-)0.1	μA
DC Current Gain	h _{FE}	V _{CE} =(-)2V, I _C =(-)100mA	200		560	
Gain-Bandwidth Product	f _T	V _{CE} =(-)10V, I _C =(-)300mA		420		MHz
Output Capacitance	Cob	V _{CB} =(-)10V, f=1MHz		(9)6		pF
Collector-to-Emitter Saturation Voltage	V _{CE(sat)}	I _C =(-)500mA, I _B =(-)10mA		(-280)	(-430)	mV
				130	190	mV
		I _C =(-)300mA, I _B =(-)6mA		(-145)	(-220)	mV
				90	135	mV
Base-to-Emitter Saturation Voltage	V _{BE(sat)}	I _C =(-)500mA, I _B =(-)10mA		(-)0.81	(-)1.2	V
Collector-to-Base Breakdown Voltage	V _{(BR)CBO}	I _C =(-)10μA, I _E =0A	(-50)60			V
Collector-to-Emitter Breakdown Voltage	V _{(BR)CEO}	I _C =(-)1mA, R _{BE} =∞	(-)50			V
Emitter-to-Base Breakdown Voltage	V _{(BR)EBO}	I _E =(-)10μA, I _C =0A	(-)5			V
Turn-On Time	t _{on}	See specified Test Circuit.		(36)38		ns
Storage Time	t _{stg}			(173)332		ns
Fall Time	t _f			(28)40		ns

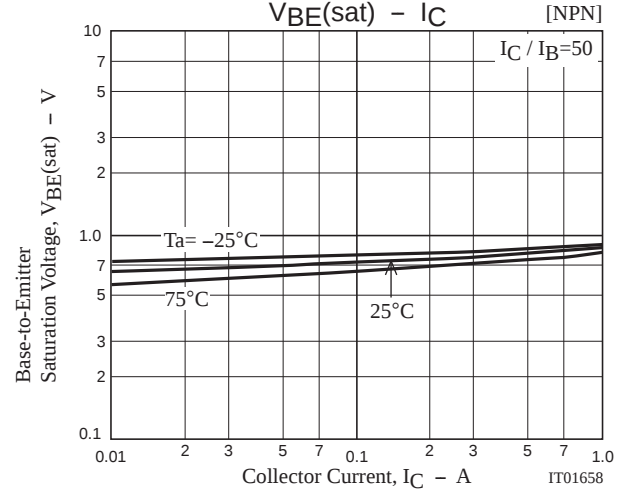
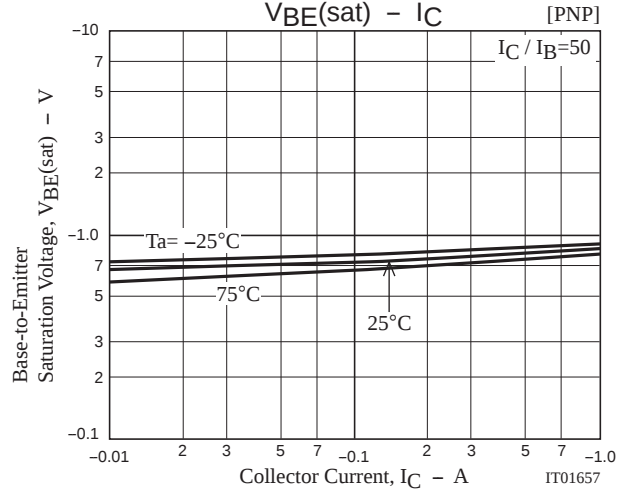
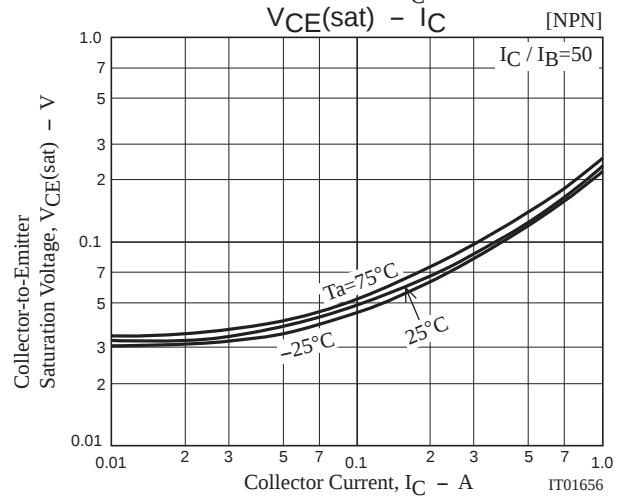
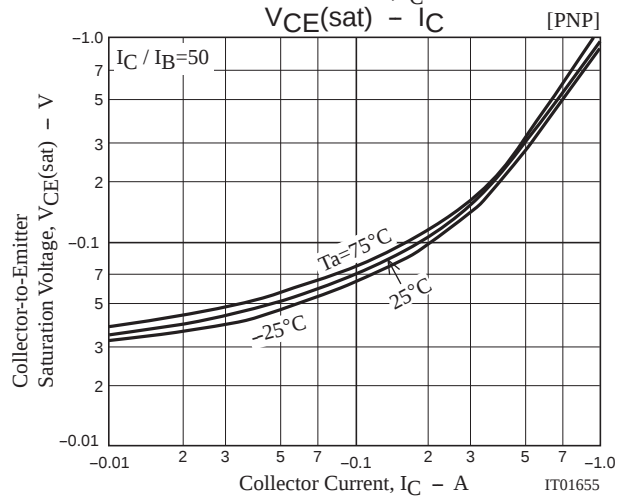
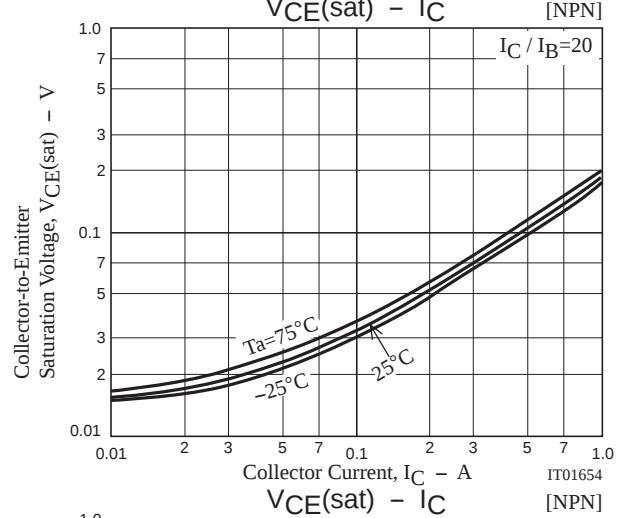
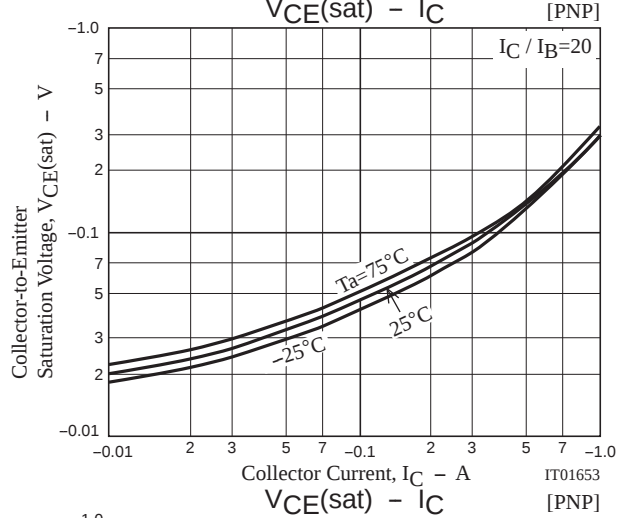
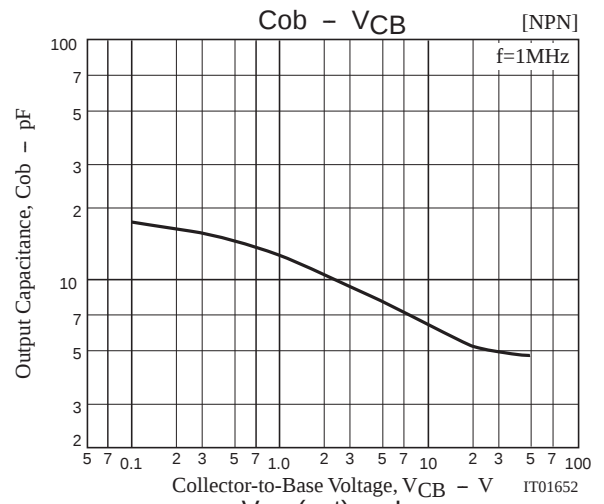
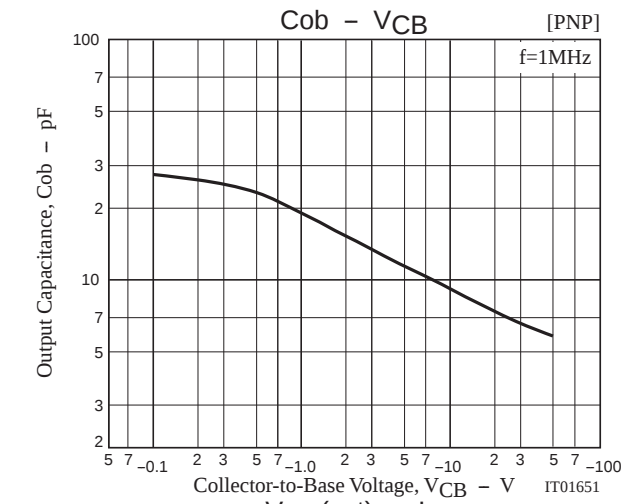
Switching Time Test Circuit

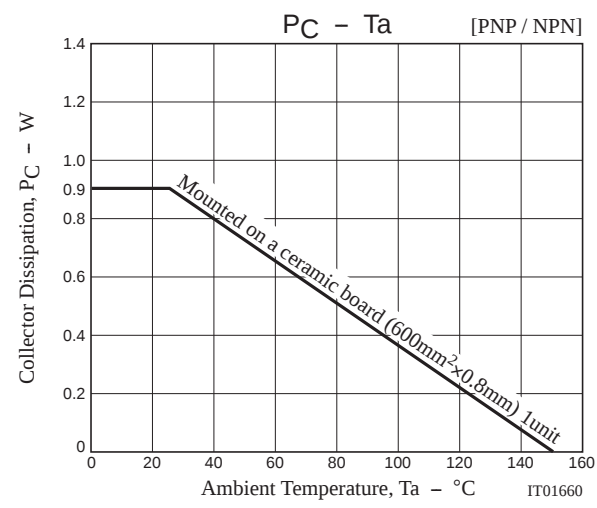
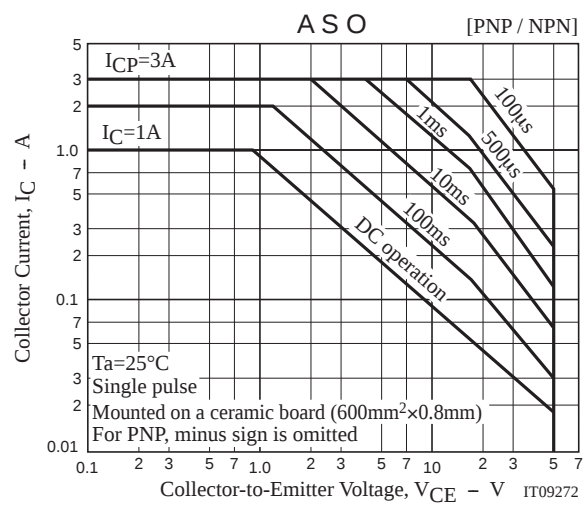


Ordering Information

Device	Package	Shipping	memo
CPH5517-TL-E	CPH5	3,000pcs./reel	Pb Free







Embossed Taping Specification

CPH5517-TL-E

1. Packing Format

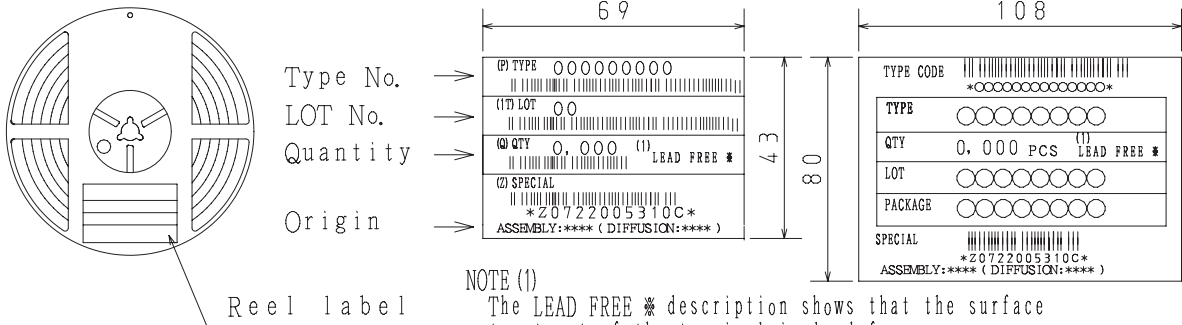
Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
CPH5	CPH6	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Reel label, Inner box label
(unit:mm)

Outer box label

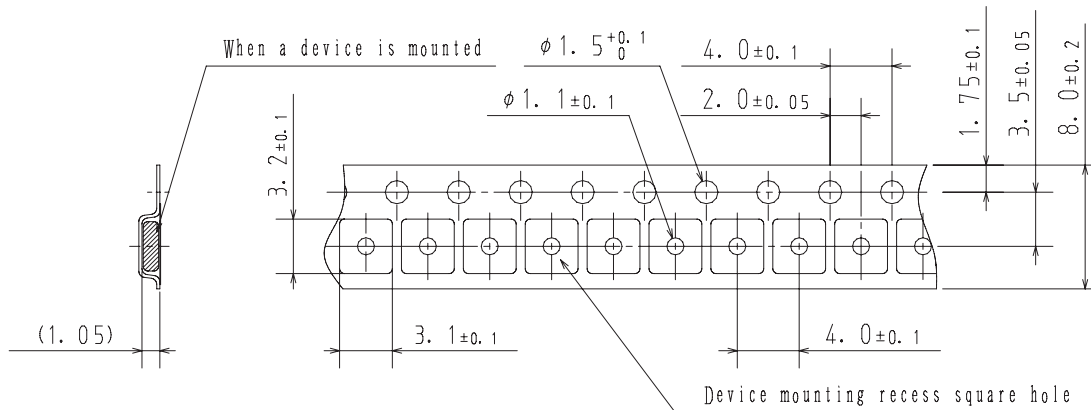
It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.

Packing method

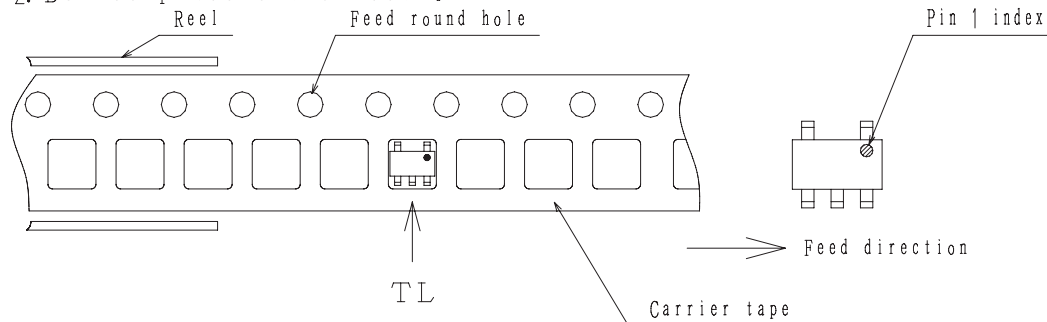


2. Taping configuration

2-1. Carrier tape size (unit:mm)

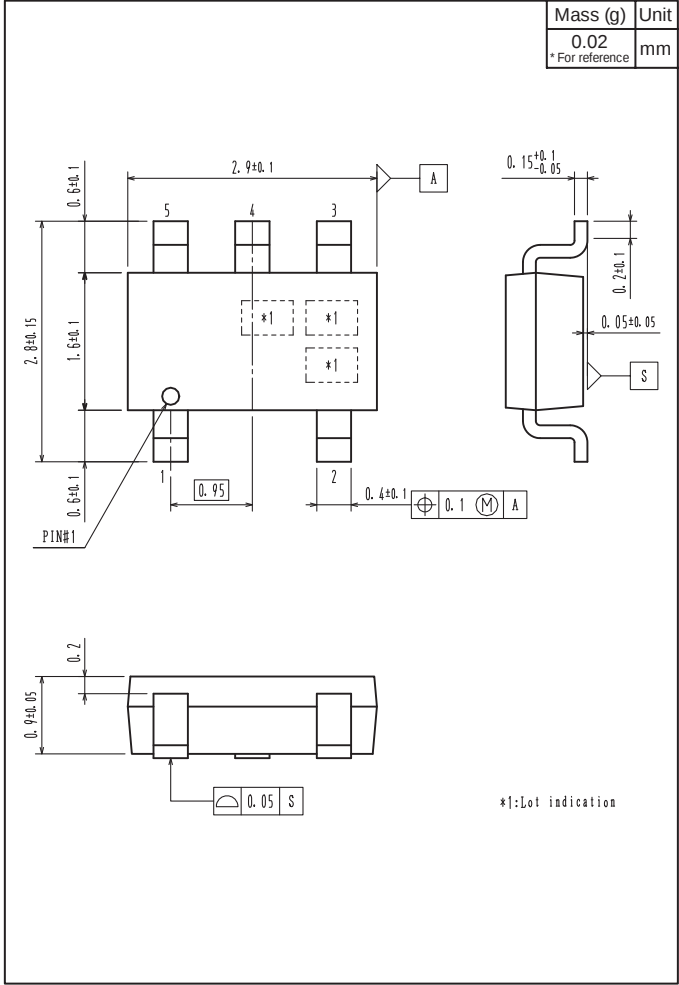


2-2. Device placement direction

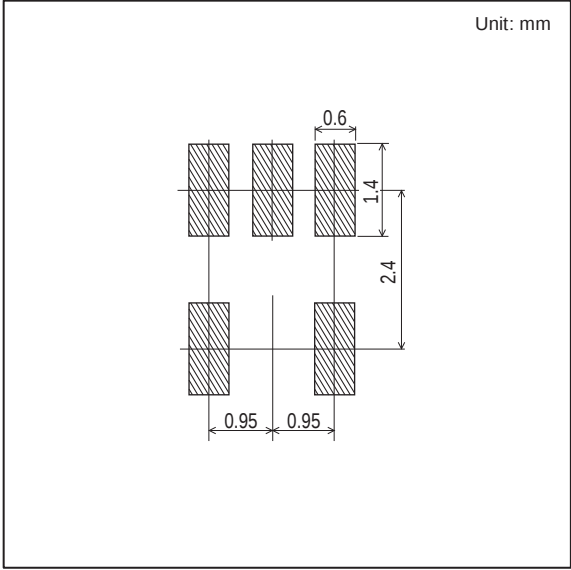


Those with pin 1 index on the feed hole side.....TL

Outline Drawing
CPH5517-TL-E



Land Pattern Example



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